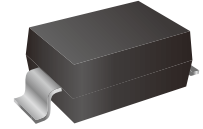


## Surface Mount Fast Recovery Rectifier

### Features

- For surface mounted applications
- Low profile package
- Glass Passivated Chip Junction
- Easy to pick and place
- Fast reverse recovery time
- Lead free in comply with EU RoHS 2011/65/EU directives



### Mechanical Data

- Case:SMAW
- Terminal:Leads solderable per MIL-STD-750 Method 2026
- Polarity:Color band denotes cathode end
- Mounting Position:Any



### Ordering Information

Part Number	Shipping	Reel
LTR1AW THRU LTR1MW	8000PCS Tape&Reel	13 inchs

### Maximum Ratings and Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.  
 Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter	Symbol	LTR1AW	LTR1BW	LTR1DW	LTR1GW	LTR1JW	LTR1KW	LTR1MW	Unit
	Marking	R1AW	R1BW	R1DW	R1GW	R1JW	R1KW	R1MW	
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	$V_{RMS}$	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	$V_{DC}$	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current at $T_c=125^\circ\text{C}$	$I_{F(AV)}$	1							A
Peak Forward Surge Current 8.3ms Single Half Sine Wave Superimposed on Rated Load	$I_{FSM}$	30							A
Maximum Forward Voltage at 1 A	$V_F$	1.3							V
Maximum DC Reverse Current $T_a = 25^\circ\text{C}$ at Rated DC Blocking Voltage $T_a = 125^\circ\text{C}$	$I_R$	5 50							$\mu\text{A}$
Typical Junction Capacitance at $V_R=4\text{V}$ , $f=1\text{MHz}$	$C_J$	15							pF
Maximum Reverse Recovery Time (Note1)	$T_{RR}$	150				250	500	ns	
Typical Thermal Resistance (Note2)	$R_{\theta JA}$	75							$^\circ\text{C/W}$
Operating and Storage Temperature Range	$T_J, T_{STG}$	-55 ~ +150							$^\circ\text{C}$

Note:(1) Measured with  $I_F = 0.5\text{ A}$ ,  $I_R = 1\text{ A}$ ,  $I_{rr} = 0.25\text{ A}$ .

(2) P.C.B. mounted with 1.0" x 1.0" (2.54cm x 2.54 cm) copper pad areas.



## Characteristics Curves

FIG.1 FORWARD CURRENT DERATING CURVE

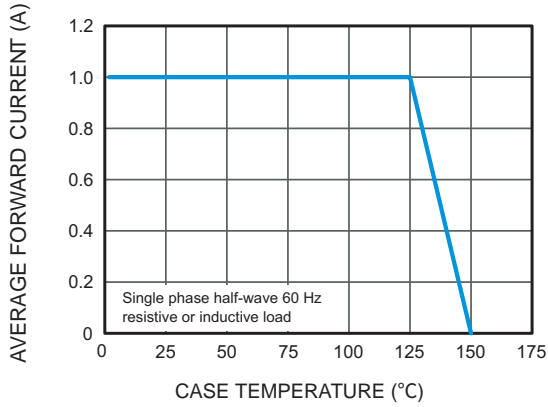


FIG.2 TYPICAL REVERSE CHARACTERISTICS

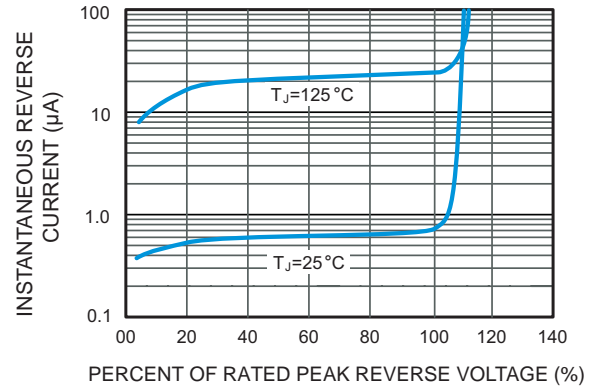


FIG.3 TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

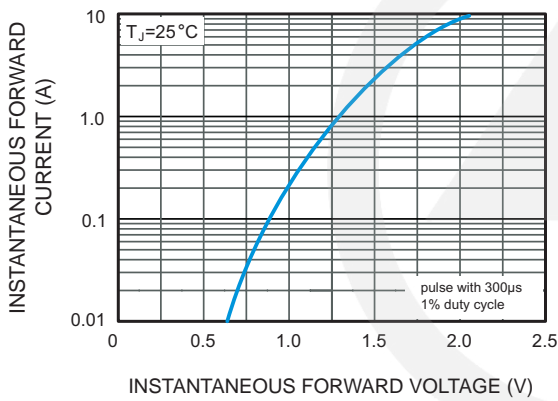


Fig. 4 TYPICAL JUNCTION CAPACITANCE

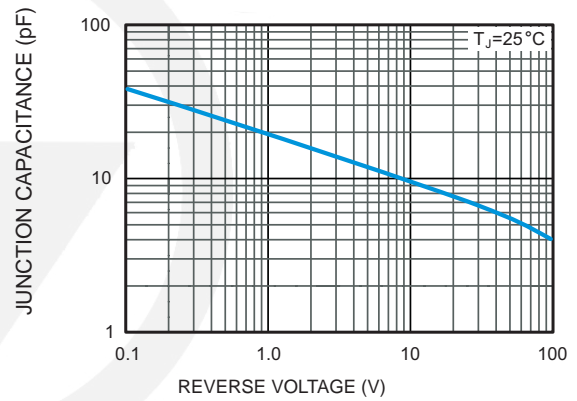
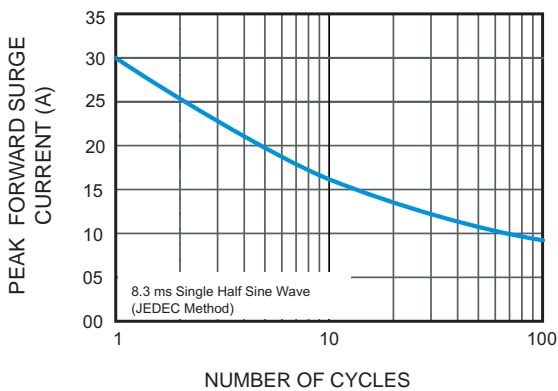
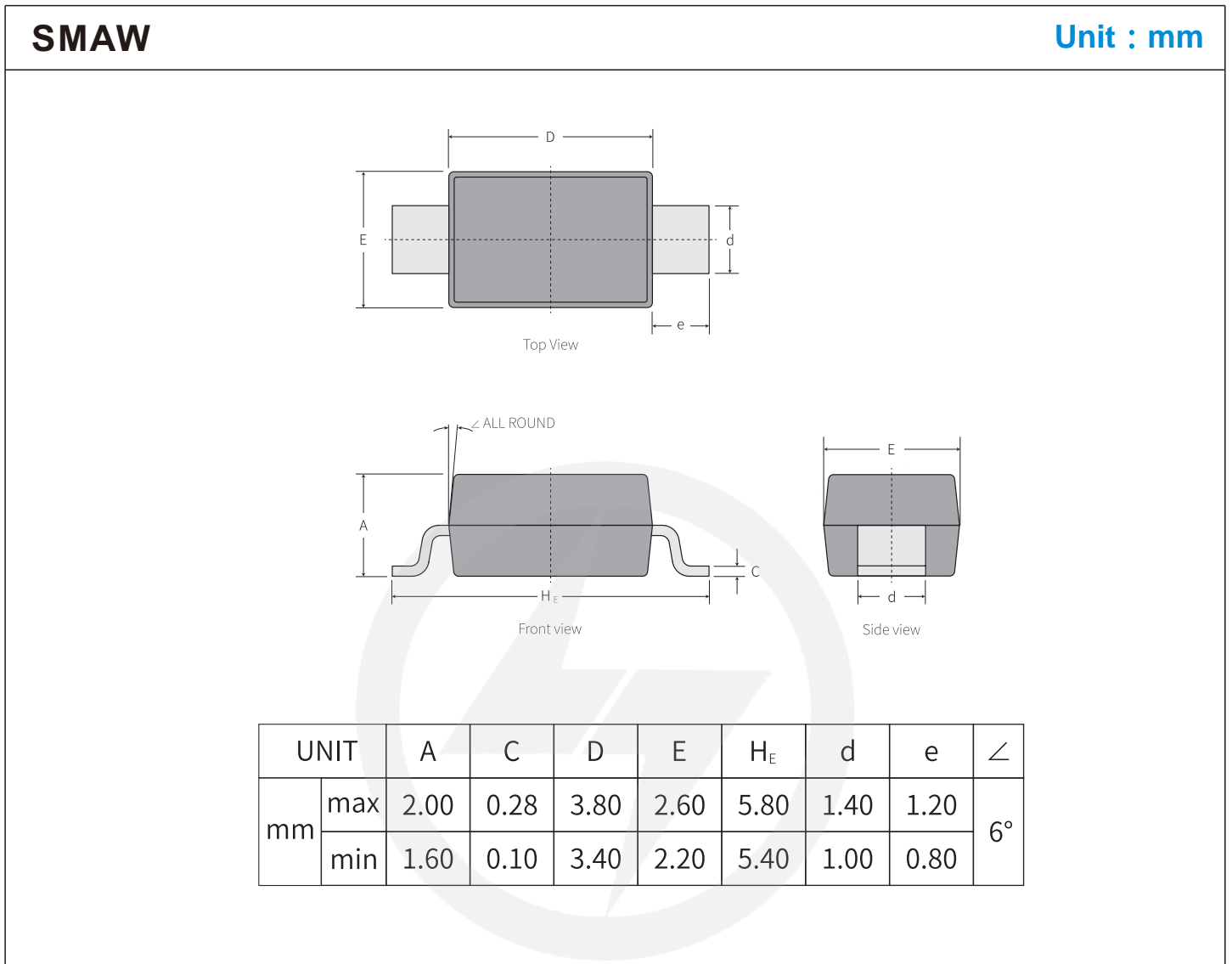


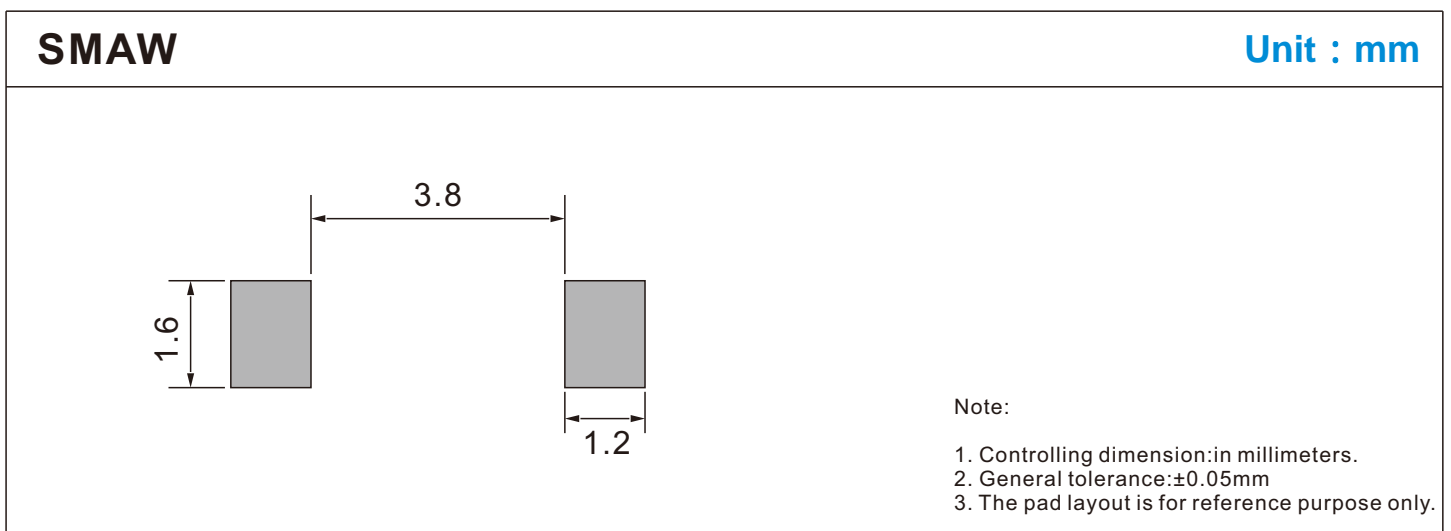
FIG.5 MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT



## Package Outline

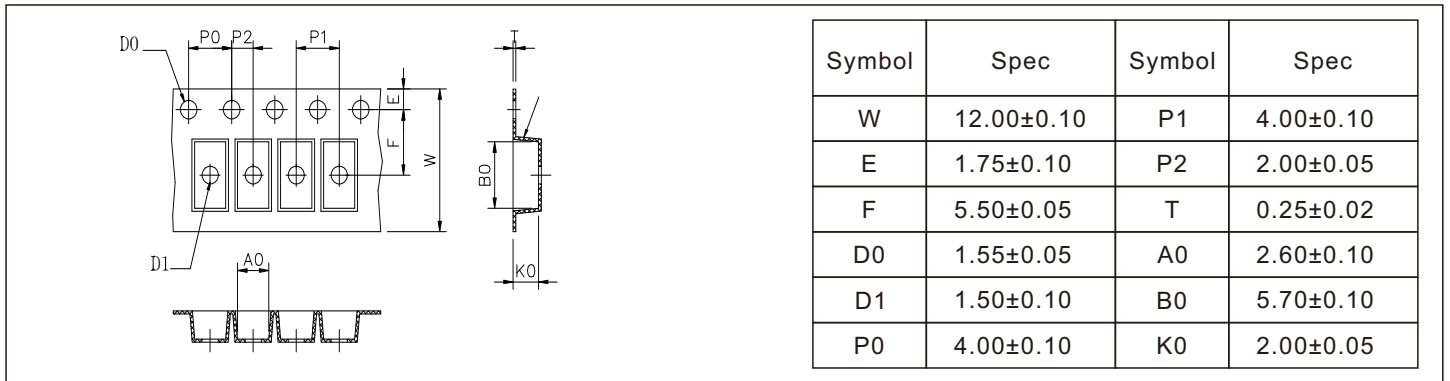


## Suggested Pad Layout



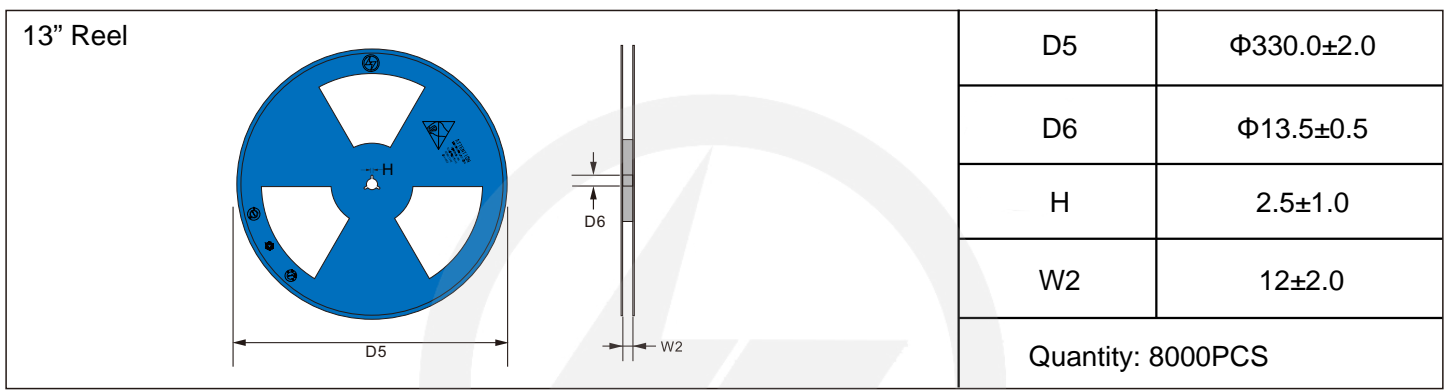
## Carrier Tape Dimensions

Unit : mm

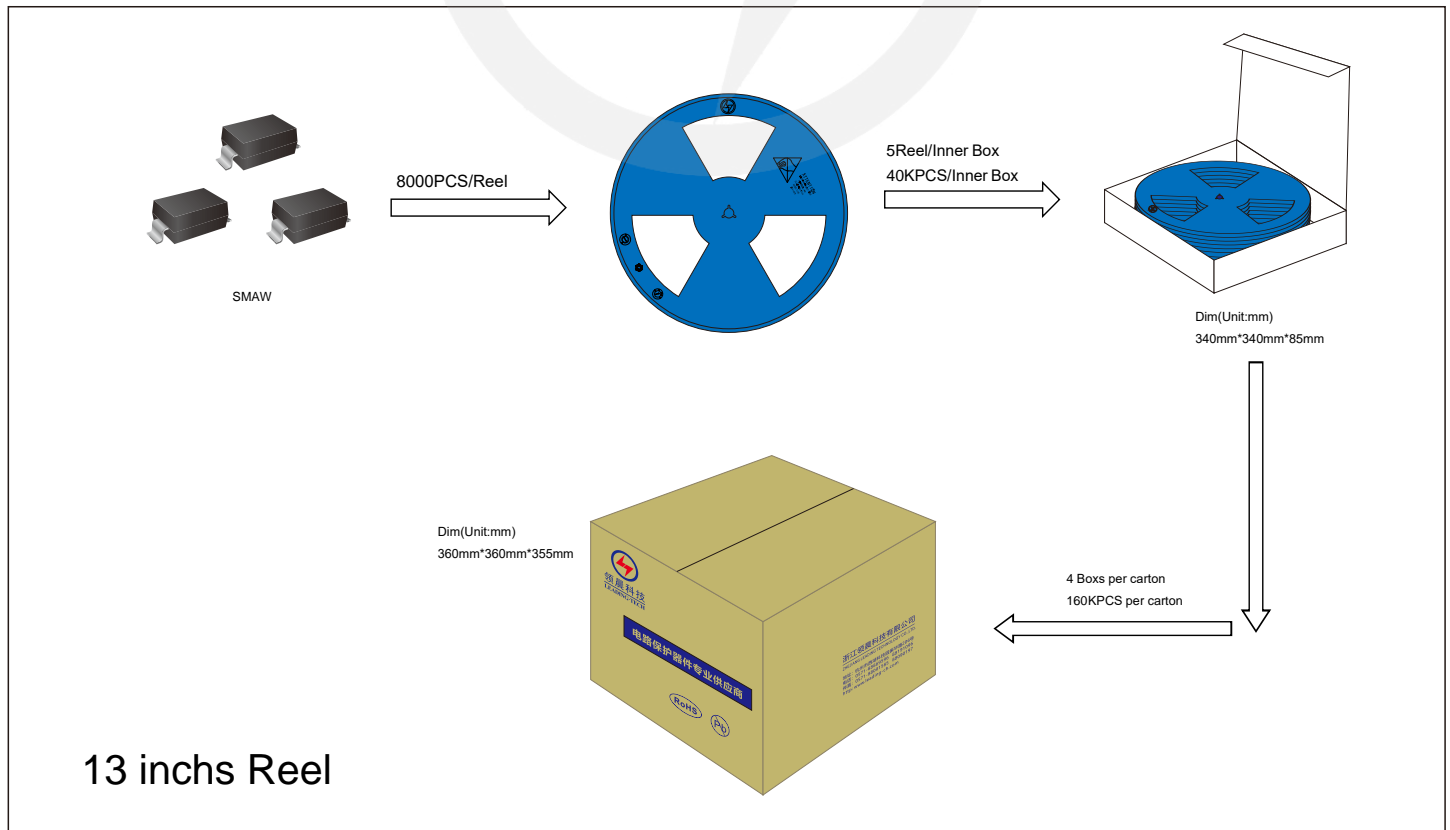


## Reel Dimensions

Unit : mm



## Packaging





**Recommended Soldering Conditions**



**Recommended Conditions**

Profile Feature	Pb-Free Assembly
Average ramp-up rate ( $T_L$ to $T_P$ )	3°C/second max.
Preheat	
-Temperature Min ( $T_{S\ min}$ )	150°C
-Temperature Max ( $T_{S\ max}$ )	200°C
-Time (min to max) ( $t_s$ )	60-180 seconds
$T_{S\ max}$ to $T_L$	
-Ramp-up Rate	3°C/second max.
Time maintained above:	
-Temperature ( $T_L$ )	217°C
-Time ( $t_L$ )	60-150 seconds
Peak Temperature ( $T_P$ )	260°C
Time within 5°C of actual Peak Temperature ( $t_p$ )	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.

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## Version Update Information

Series NO.	Enactment/Revision Date	Effective Date	Version	Revision content	Revision Reason	Revision Person	Note
01	2023.11.29	2023.11.29	1.0	New File	/	Ding	
02	2025.06.30	2025.06.30	1.1	Update packaging information	/	Ding	